To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HD74LS112

Dual J-K Negative-edge-triggered Flip-Flops (with Preset and Clear)

REJ03D0426–0300
Rev.3.00
Jul.13.2005

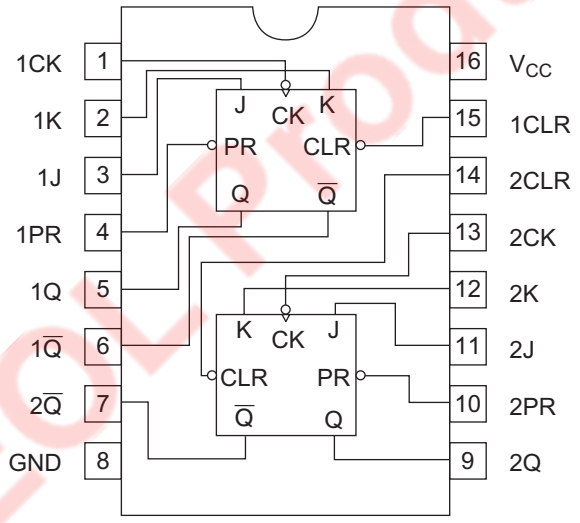
Features

- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS112P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	P	—
HD74LS112FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)
HD74LS112RPEL	SOP-16 pin (JEDEC)	PRSP0016DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

Pin Arrangement



(Top view)

Function Table

Inputs					Outputs	
Preset	**Clear**	**Clock**	**J**	**K**	**Q**	**$\overline{Q}$**
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H*	H*
H	H	↓	L	L	Q_O	$\overline{Q}_O$
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	Toggle	
H	H	H	X	X	Q_O	$\overline{Q}_O$

Notes: H; high level, L; low level, X; irrelevant

↓; transition from high to low level

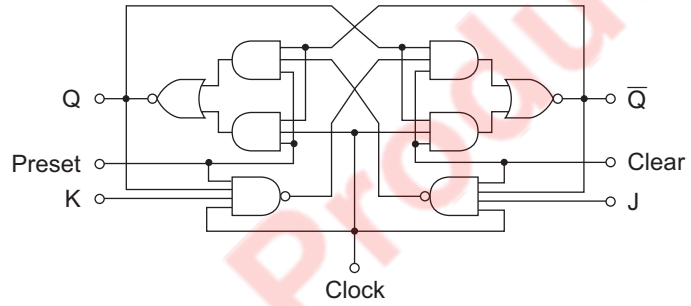
Q; level of Q before the indicated steady-state input conditions were established.

$\overline{Q}$; complement of Q_O or level of $\overline{Q}$ before the indicated steady-state input conditions were established.

Toggle; each output changes to the complement of its previous level on each active transition indicated by ↓.

*; This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (high) level.

Block Diagram (1/2)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P_T	400	mW
Storage temperature	Tstg	–65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item		Symbol	Min	Typ	Max	Unit
Supply voltage		V_{CC}	4.75	5.00	5.25	V
Output current		I_{OH}	—	—	–400	µA
		I_{OL}	—	—	8	mA
Operating temperature		Topr	–20	25	75	°C
Clock frequency		f_{clock}	0	—	30	MHz
Pulse width	Clock High	t_w	20	—	—	ns
	Clear Preset Low		25	—	—	ns
Setup time	"H" Data	t_{su}	20↓			ns
	"L" Data		20↓	—	—	ns
Hold time		t_h	0↓	—	—	ns

Electrical Characteristics

(Ta = –20 to +75 °C)

Item		Symbol	min.	typ.*	max.	Unit	Condition
Input voltage		V_{IH}	2.0	—	—	V	
		V_{IL}	—	—	0.8	V	
Output voltage		V_{OH}	2.7	—	—	V	V_{CC} = 4.75 V, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = –400 µA
		V_{OL}	—	—	0.5	V	I_{OL} = 8 mA, V_{CC} = 4.75 V, V_{IH} = 2 V, V_{IL} = 0.8 V
			—	—	0.4		I_{OL} = 4 mA, V_{CC} = 4.75 V, V_{IH} = 2 V, V_{IL} = 0.8 V
Input current	J, K	I_{IH}	—	—	20	µA	V_{CC} = 5.25 V, V_I = 2.7 V
	Clear		—	—	60		
	Preset		—	—	60		
	Clock		—	—	80		
	J, K	I_{IL}**	—	—	–0.4	mA	V_{CC} = 5.25 V, V_I = 0.4 V
	Clear		—	—	–0.8		
	Preset		—	—	–0.8		
	Clock		—	—	–0.8		
	J, K	I_I	—	—	0.1	mA	V_{CC} = 5.25 V, V_I = 7 V
	Clear		—	—	0.3		
	Preset		—	—	0.3		
	Clock		—	—	0.4		
Short-circuit output current		I_{OS}	–20	—	–100	mA	V_{CC} = 5.25 V
Supply current***		I_{CC}	—	4	8	mA	V_{CC} = 5.25 V
Input clamp voltage		V_{IK}	—	—	–1.5	V	V_{CC} = 4.75 V, I_{IN} = –18 mA

Notes: * V_{CC} = 5 V, Ta = 25°C

** I_{IL} should not be measured when preset and clear inputs are low at same time.

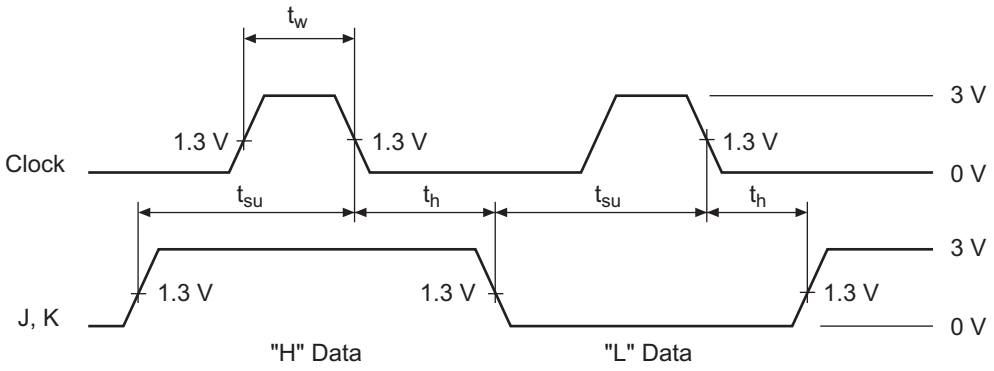
*** With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the tires of measurement, the clock input is grounded.

Switching Characteristics

(V_{CC} = 5 V, Ta = 25°C)

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Maximum clock frequency	f_{max}			30	45	—	MHz	C_L = 15 pF, R_L = 2 kΩ
Propagation delay time	t_{PLH}	Clear Preset Clock	Q, $\overline{Q}$	—	11	20	ns	
	t_{PHL}			—	15	30	ns	

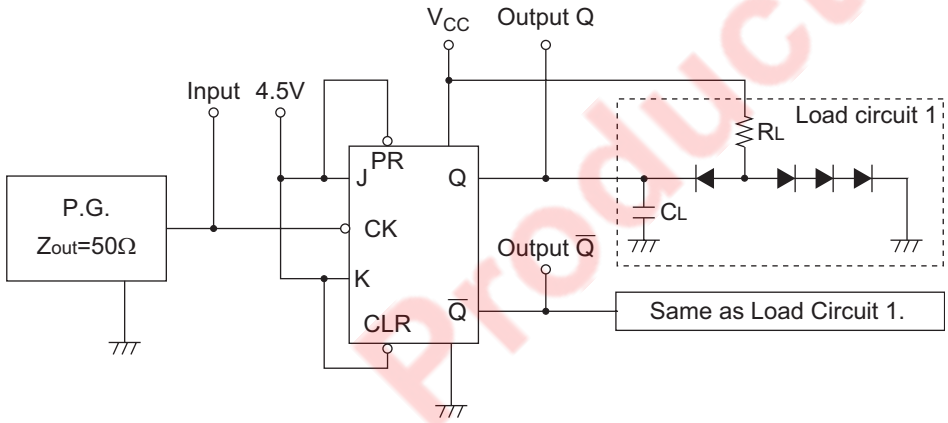
Timing Definition



Testing Method

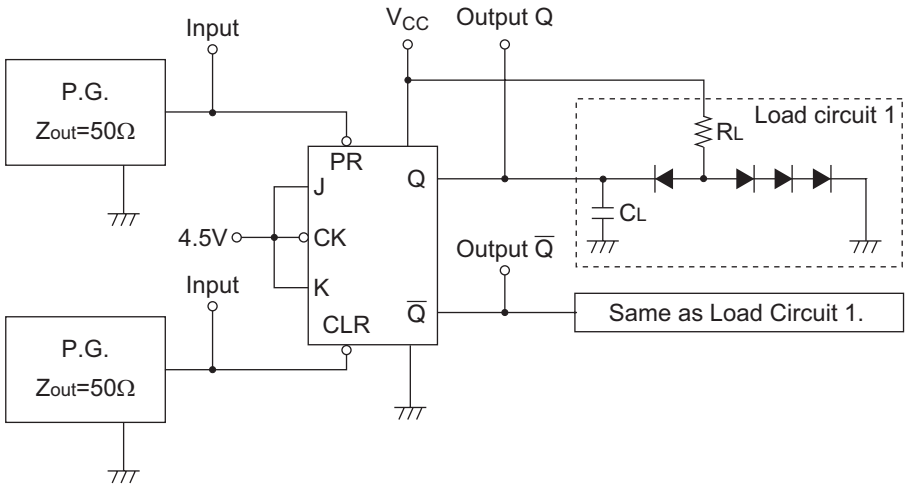
Test Circuit

1. f_{max}, t_{PLH}, t_{PHL}, (Clock→Q, $\overline{Q}$)



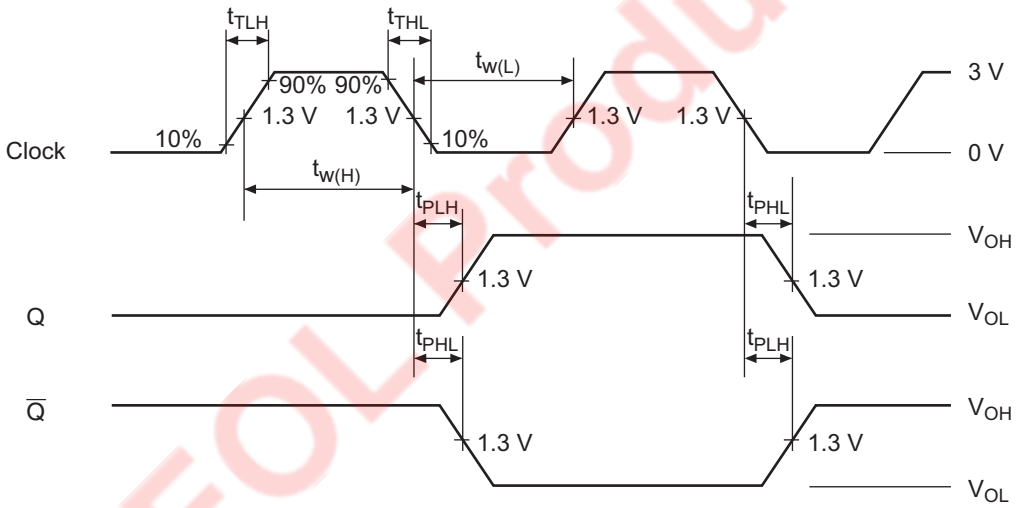
Notes:
1. Test is put into the each flip-flop.
2. C_L includes probe and jig capacitance.
3. All diodes are 1S2074(H).

2. t_{PHL}, t_{PLH}, (Clear, Preset→Q, $\overline{Q}$)



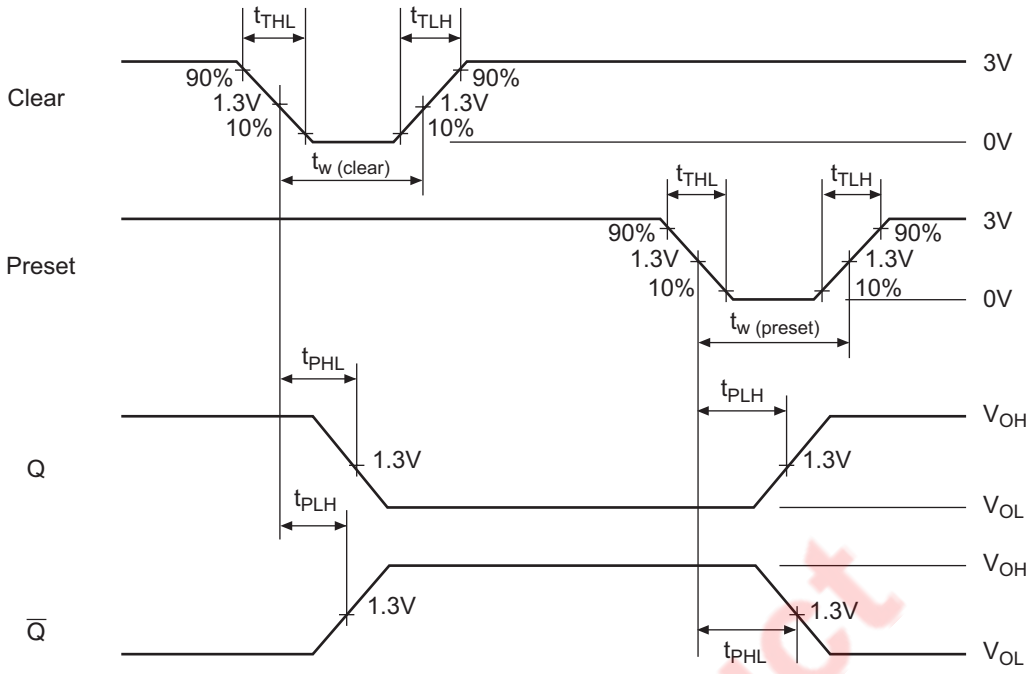
Notes:
1. Test is put into the each flip-flop.
2. C_L includes probe and jig capacitance.
3. All diodes are 1S2074(H).

Waveforms 1



Note: Clock input pulse: $t_{TLH} \leq 15$ ns, $t_{THL} \leq 6$ ns, PRR = 1 MHz, duty cycle = 50%
and: for f_{max}, t_{THL} $t_{THL} \leq 2.5$ ns.

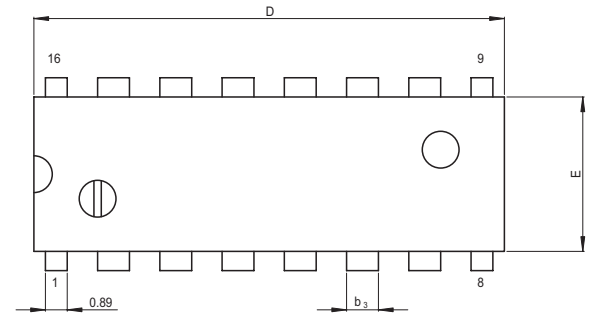
Waveforms 2

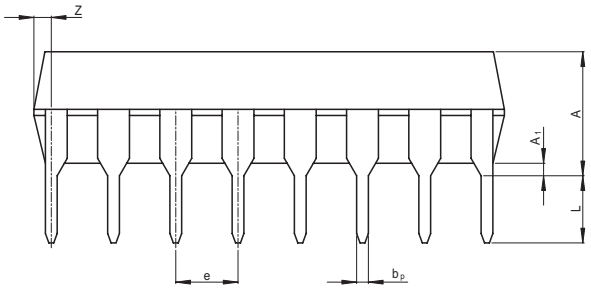


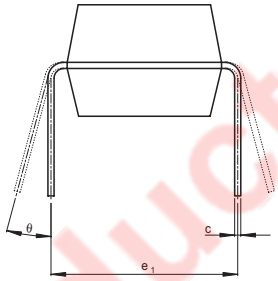
Note: Clear and clock input pulse: $t_{TLH} \leq 15$ ns, $t_{THL} \leq 6$ ns, PRR = 1 MHz.

Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-DIP16-6.3x19.2-2.54	PRDP0016AE-B	DP-16FV	1.05g



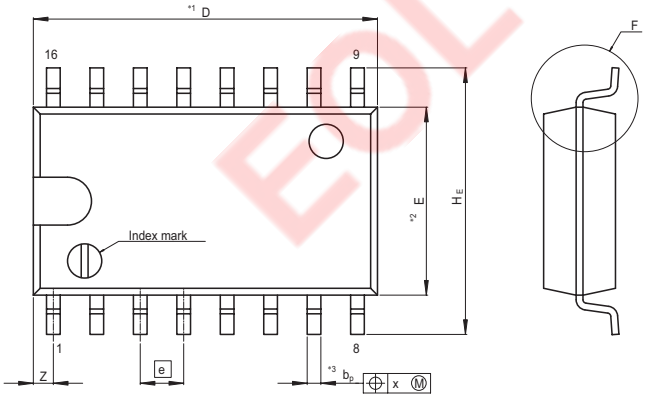


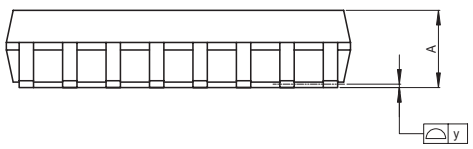


(Ni/Pd/Au plating)

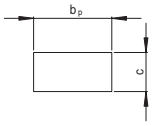
Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
e 1	——	7.62	——
D	——	19.2	20.32
E	——	6.3	7.4
A	——	——	5.06
A 1	0.51	——	——
b p	0.40	0.48	0.56
b 3	——	1.30	——
c	0.19	0.25	0.31
θ	0°	——	15°
e	2.29	2.54	2.79
Z	——	——	1.12
L	2.54	——	——

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP16-5.5x10.06-1.27	PRSP0016DH-B	FP-16DAV	0.24g

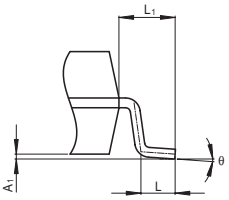




NOTE)
1. DIMENSIONS"*1 (Nom)"AND"*2"
   DO NOT INCLUDE MOLD FLASH.
2. DIMENSION"*3"DOES NOT
   INCLUDE TRIM OFFSET.



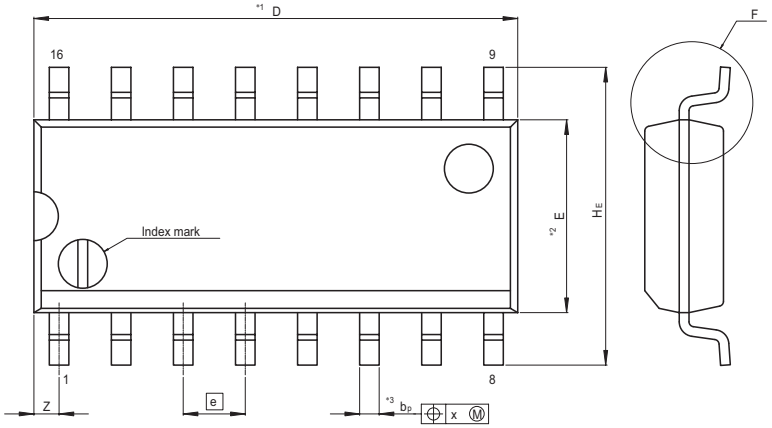
Terminal cross section
(Ni/Pd/Au plating)



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	——	10.06	10.5
E	——	5.50	——
A 2	——	——	——
A 1	0.00	0.10	0.20
A	——	——	2.20
b p	0.34	0.40	0.46
b 1	——	——	——
c	0.15	0.20	0.25
c 1	——	——	——
θ	0°	——	8°
H E	7.50	7.80	8.00
e	——	1.27	——
x	——	——	0.12
y	——	——	0.15
Z	——	——	0.80
L	0.50	0.70	0.90
L 1	——	1.15	——

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP16-3.95x9.9-1.27	PRSP0016DG-A	FP-16DNV	0.15g



NOTE)
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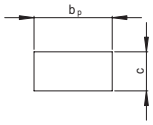
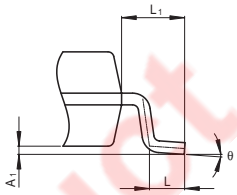
2. DIMENSION"*3"DOES NOT INCLUDE TRIM OFFSET.



Terminal cross section
(Ni/Pd/Au plating)



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	——	9.90	10.30
E	——	3.95	——
A_2	——	——	——
A_1	0.10	0.14	0.25
A	——	——	1.75
b_p	0.34	0.40	0.46
b_1	——	——	——
c	0.15	0.20	0.25
c_1	——	——	——
θ	0°	——	8°
H_E	5.80	6.10	6.20
e	——	1.27	——
x	——	——	0.25
y	——	——	0.15
Z	——	——	0.635
L	0.40	0.60	1.27
L_1	——	1.08	——

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